

ALAN GUO

Evanston, IL | hoesenguo@gmail.com

EDUCATION

Northwestern University	Evanston, USA
• Doctor of Philosophy in Computer Engineering	Jan. 2024 – Present
Northwestern University	Evanston, USA
• Master of Science in Electrical Engineering	Sep. 2022 – Dec. 2023
University of Shanghai for Science and Technology	Shanghai, China
• Bachelor of Engineering in Electronic Information Engineering	Sep. 2018 – Jun. 2022

EXPERIENCE

ASIC Design and Test Engineer	Jul. 2023 – Present
<i>Fermilab (Fermi National Accelerator Laboratory)</i>	Batavia, USA
<ul style="list-style-type: none">Responsible for testing a taped-out ADC-Readout ASIC chip including writing test routines with Spacely, a toolchain for automatic chip testsuites and performing on-site testing in FermilabParticipated in the designs of SPROCKET3 ASIC blocks with Fermilab ASIC Design GroupResponsible for back-end digital flow for Photonic Transmitter block including RTL, simulation, verification, implementing floorplan and P&R	
Research Assistant	Apr. 2023 – Present
<i>Northwestern University (Seda Ogrenci Lab)</i>	Evanston, USA
<ul style="list-style-type: none">Research on protection methods for bit-flips induced by radiations for neural network hardware acceleratorsUsing Cadence EDA tools for synthesizing, verifying, floorplanning, and P&R for various blocks and designsFamiliar with WOLF, an environment manager script for back-end digital design designed by Ogrenci Lab	
Hardware Test Engineer	Jul. 2021 – Aug. 2021
<i>Shanghai STEP Electric Corporation</i>	Shanghai, China
<ul style="list-style-type: none">Tested various data against the diagrams of circuit boards and provided suggestions for the R&D departmentDesigned schematic diagrams, conducted PCB reviews and component changes, and assisted in handling production and after-sales quality issues for future works	
Software Development	Jul. 2020 – Aug. 2020
<i>COMAC Software Co., Ltd. from Commercial Aircraft Corporation of China</i>	Chengdu, China
<ul style="list-style-type: none">Participated in the development of a company interview system in Java, solved permissions problems, and questioned banks accessing	

RESEARCH

Bitwise Susceptibility Ranking for Edge Neural Networks	Jun. 2023 – Nov. 2024
<ul style="list-style-type: none">Develop python algorithms for ranking weights in ASIC based on-edge neural networks for radiation induced environments like LHC in CERNIntegrate the algorithms with ASIC related hardware and go through back-end digital flow, ready for tape-out	
Manned Beach Car Based on STM32 with Self-designed Drive Board	Mar. 2021 – Jun. 2022
<i>Shanghai University Student Innovation and Entrepreneurship Project, Team Leader</i>	
<ul style="list-style-type: none">Design and solder H-bridge PCB circuit, use embedded C in Keil to program the STM32 MCUCombine STM32 with a self-designed DC brush drive board and a high-power motor to assemble the vehicle	

ADDITIONAL

Skills: Cadence IC Design Tools (Genus, Innovus, Virtuoso, Spectre, Xcelium), Verilog, System Verilog, UVM, Machine Learning, Python, Embedded C (Microchip Studio, Arduino, Keil), MATLAB, LabVIEW, PCB Design (Eagle, Fusion 360, KiCad), Web Design (AWS Server, HTML, JavaScript, CSS)

Languages: English, Mandarin, Shanghainese

Hobbies: Violin (in Northwestern University Philharmonia)